

## LAYER STACK

TOP SILK
TOP SOLDER RESIST
WHITE
TOP ELECTRIC
INNER FR4
BOTTOM ELECTRIC
BOTTOM SOLDER RESIST
WHITE
BOTTOM SILK
BLACK

- 1.) All dimensions are metric
- 2.) Number of electrical layers 2
- 3.) Minimal track/spacing 0.20/0.20
- 4.) Minimal drill 0.30
- 5.) See LAYER STACK for layer specification
- 6.) PCB size 65.00×56.00 +/- 0.1(mm)
- 7.) PCB finish HASL
- 8.) Material FR4
- 9.) Solder resist LPSIM
- 10.) Solder resist color WHITE
- 11.) Silk color BLACK
- 12.) GERBER file format RS-274-X
- 13.) DRILL file format EXCELLON 4/4/Abs/mm/none
- 14.) Showed drill diameters are for finished drills
- 15.) For tool table see tool\_table.rpt
- 16.) All traces must be 100% electricaly

checked for shorts and opens

- 17.) PCB assembly according to IPC-A-610E Class I
- 18.) Paneling to be decided by ECM partner
- 19.) SOLDER PASTE layers to be adjusted by ECM

APPROVALS	VALS DA						
DRAWN: J.J.	13.07.2015.						
CHECKED: J.J.	13.07.2015.		Pi-ePaper				
APPROVED:			PCB				
PI-SUPPLY		Size:	Drawing number: 2014-035-02	Scale:	Sheet:	Ver.	Rev.
		A4	File name: 2014-035-PI_EPAPER_v1_6.pcb	1:1	1 of 1	1.6	